PD3S120L

1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

PowerDI®323

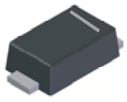
Please click here to visit our online spice models database.

Features

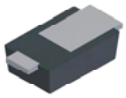
- Guard Ring Die Construction for Transient Protection
- High Surge Capability
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **"Green" Molding Compound (No Br, Sb)**
- **Ultra-Small Surface Mount Package**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: PowerDI®323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Polarity: Cathode Band
- Terminals: Finish - Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 e3
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.006 grams (approximate)



Top View



Bottom View

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	V
RMS Reverse Voltage	$V_{R(RMS)}$	14	V
Average Forward Current (See also figure 4)	$I_{F(AV)}$	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	33	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{\theta JS}$	—	6	°C/W
Thermal Resistance Junction to Ambient Air (Note 2)	$R_{\theta JA}$	170	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 3)	$R_{\theta JA}$	144	—	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +125		°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 4)	$V_{(BR)R}$	20	—	—	V	I_R = 100μA
Forward Voltage	V_F	— — — —	0.27 0.34 0.36 0.27	0.31 0.38 0.42 0.30	V	I_F = 0.1A, T_A = 25ºC I_F = 0.7A, T_A = 25ºC I_F = 1.0A, T_A = 25ºC I_F = 1.0A, T_A = 125ºC
Leakage Current (Note 4)	I_R	—	10 13 30 11	50 60 160 30	μA μA μA mA	V_R = 5V, T_A = 25°C V_R = 10V, T_A = 25°C V_R = 20V, T_A = 25°C V_R = 20V, T_A = 125°C
Total Capacitance	C_T	—	46	—	pF	V_R = 10V, f = 1.0MHz

Notes:
1. EU Directive **2002/95/EC** (RoHS). All applicable RoHS exemptions applied, see *EU Directive **2002/95/EC** Annex Notes.*
2. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
3. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
4. Short duration pulse test to minimize self-heating effect.

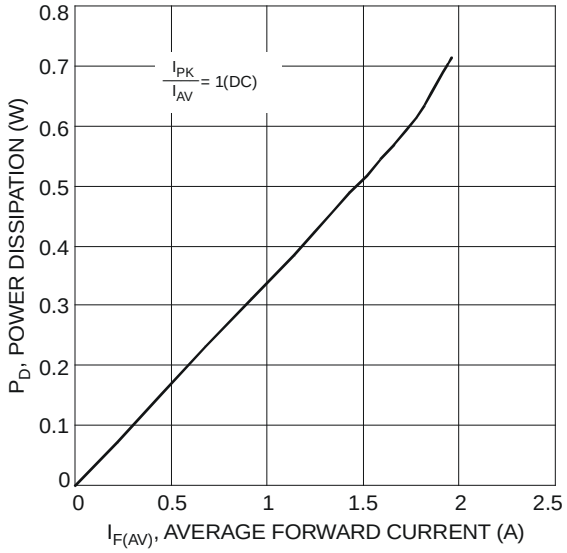


Fig. 1 Forward Power Dissipation

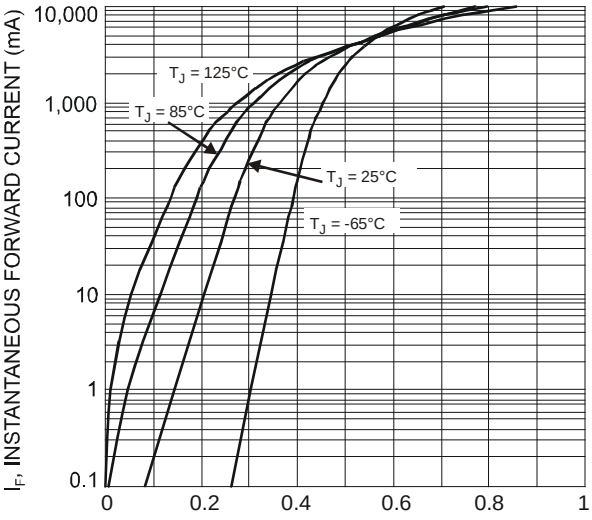


Fig. 2 Typical Forward Characteristics

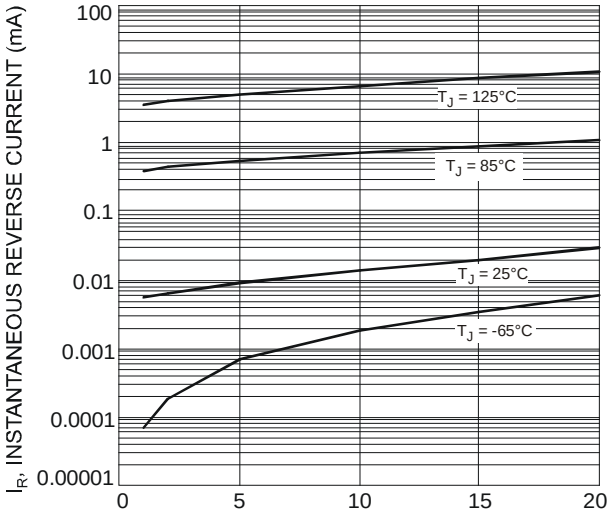


Fig. 3 Typical Reverse Characteristics

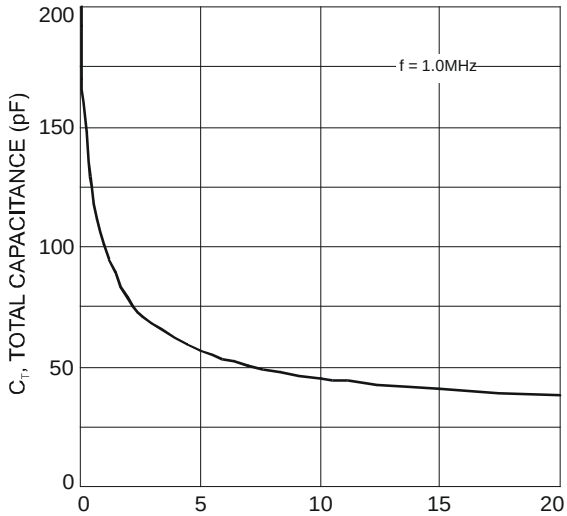


Fig. 4 Total Capacitance vs. Reverse Voltage

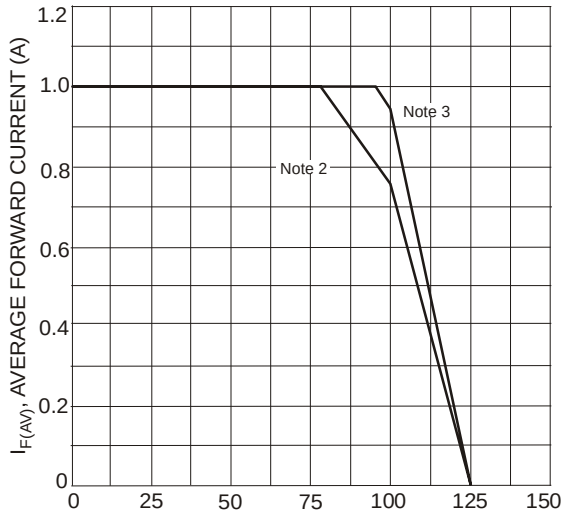


Fig. 5 Forward Current Derating Curve

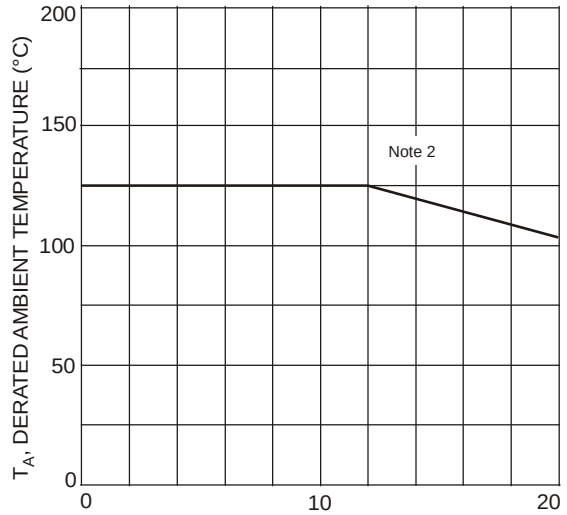


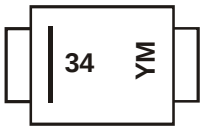
Fig. 6 Operating Temperature Derating

Ordering Information (Note 5)

Part Number	Case	Packaging
PD3S120L-7	PowerDI®323	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



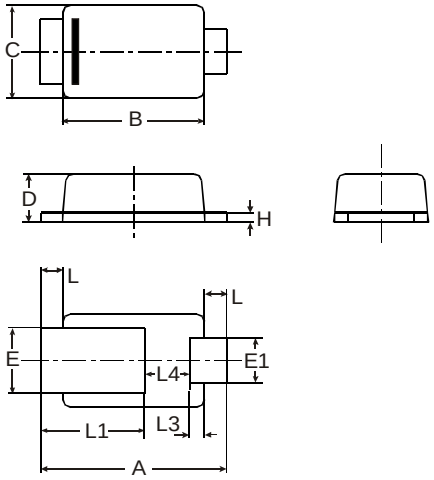
34 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: U = 2007)
M = Month (ex: 9 = September)

Date Code Key

Year	2006	2007	2008	2009	2010	2011	2012
Code	T	U	V	W	X	Y	Z

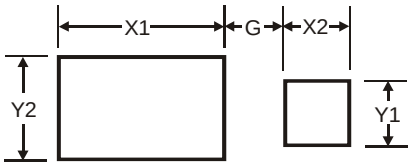
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Package Outline Dimensions



PowerDI®323			
Dim	Min	Max	Typ
A	2.40	2.60	2.50
B	1.85	1.95	1.90
C	1.20	1.30	1.25
D	0.60	0.70	0.65
E	0.78	0.98	0.88
E1	0.50	0.70	0.60
H	0.08	0.18	0.13
L	0.20	0.40	0.30
L1	—	—	1.40
L3	—	—	0.20
L4	0.40	0.80	0.60
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
G	0.5
X1	2.0
X2	0.8
Y1	0.8
Y2	1.1